

### **Technical Data Sheet**

**MODEL NO**: **Q196Y4** Package: 1.6\*08\*0.6mm LED

#### Features:

- Package in 8mm tape on 7" diameter reel
- Compatible with automatic placement equipment
- Compatible with reflow solder process

### Applications:

- Optical Indicator
- Indoor Display
- Automotive Lighting
- Backlight for LCD, Display
- Tubular Light Application

#### **Features**

- High lumen output and efficacy
- Uses the eutectic technology, with low thermal resistance and high reliability characteristics.
- Suitable for different working environment

Dice material	Emitted color	Lens Color
AlGaInP	Yellow	Water Clear

### Electrical/Optical Characteristics(Ta=25℃)

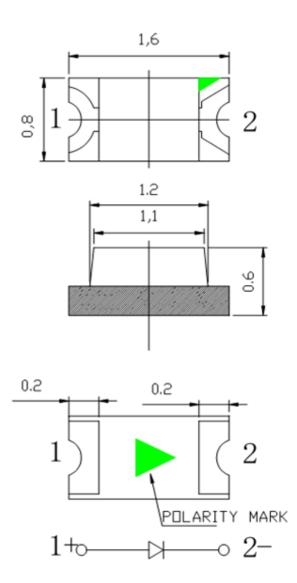
Parameter	Test	Symbol	Value			Unit
	Condition		Min	Тур	Max	UIIIL
Dominant wavelength	IF=20mA	WD	588		592	nm
Forward voltage	IF=20mA	VF	1.6		2.2	V
Luminous intensity	IF=20mA	lv	100		150	mcd
Reverse current	V <sub>R</sub> =5V	lR			10	μА
Viewing angle at 50% lv	If=20mA	2 <i>0</i> 1/2		120		Deg

### Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Value	Unit
Power dissipation	Pd	72	mW
Forward current	lf	20	mA
Reverse voltage	VR	5	V
Operating temperature range	Тор	-20 ~+80	$^{\circ}\!\mathbb{C}$
Storage temperature range	Tstg	-40 ~+85	$^{\circ}\!\mathbb{C}$
Peak pulsing current (1/8 duty f=1kHz)	lfp	125	mA



# PACKAGING DIMENSIONS (mm):

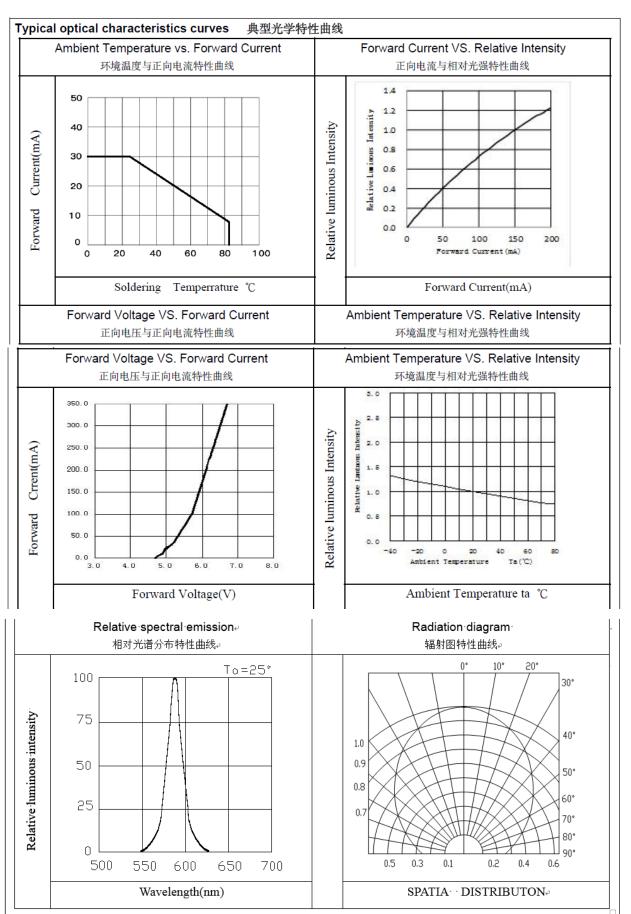


Notes:(备注)

1. All dimension units are millimeters. (所有标注尺寸单位为毫米)

2.All dimension tolerance is ±0.15mm unless otherwise noted. (除特别标注外,所有尺寸允许公差±0.15mm )





### **Precautions For Use:**

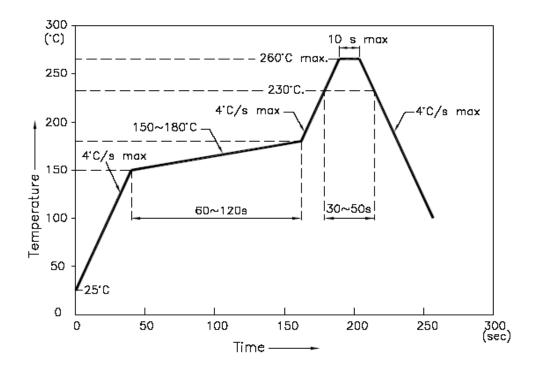
### Over - current - proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

### Storage

- 1. The operation of temperature and R.H. are :  $5^{\circ}$ C  $\sim 30^{\circ}$ C, 60%R.H. Max.
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
- 3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is :  $60^{\circ}\text{C}\pm5^{\circ}\text{C}$  for 15hrs.

### ■ Reflow Temp/Time



#### NOTES:

- 1. We recommend the reflow temperature  $245\,^{\circ}\text{C}(\pm 5\,^{\circ}\text{C})$ .the maximum soldering temperature should be limited to  $260\,^{\circ}\text{C}$ .
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

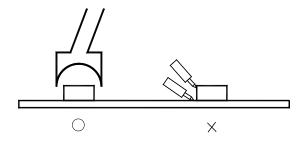


### ■Soldering iron

Basic spec is  $\leq$  5sec when 260°C. If temperature is higher, time should be shorter (+10°C  $\rightarrow$  -1sec ). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

### **■**Rework

- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow \, solder etc.